A Unit of Teledyne Electronics and Communications

1A, 80 Vdc Optically Isolated **Short-Circuit Protected**

FEATURES/BENEFITS

- · Short-circuit protected
- · Overload trip
- Low off-state leakage current
- · Optical isolation
- · Compact package



Part Number	Description
ZD20CD*	1A, 80 Vdc, short-circuit protected up to 60 Vdc, solid-state relay for through-hole mounting
SZD20CD*	1A, 80 Vdc, short-circuit protected up to 60 Vdc, solid-state relay for surface mount
*T, W level screening av	vailable

ELECTRICAL SPECIFICATIONS

(-55°C to +105°C ambient temperature unless otherwise specified)

INPUT (CONTROL) SPECIFICATIONS

	Min	Max	Units
Input Current	8	20	mA
Input Voltage @10mA	2	3	Vdc
Must Turn-On	8		mA
Must Turn-Off Current		100	μA
Must Turn-Off Voltage		0.8	Vdc
Reverse Polarity	-6		Vdc

OUTPUT (LOAD) SPECIFICATIONS

	Min	Max	Units
Load Voltage Range	0	80	Vdc
Output Current Rating (See Figure 6)		1.0	Α
Leakage Current at Rated Voltage		20	μΑ
Transient Blocking Voltage @2	25°C	100	Vdc
Output Capacitance @25Vdc	(25°C)	600	pF
Output Voltage Drop @1A		0.55	Vdc
On Resistance		0.55	Ohm
Turn-On Time		2.0	ms
Turn-Off Time		1.0	ms
Trip Overload (S	(See Figure 7)		Α
Short Circuit Protection		60	Vdc

MECHANICAL SPECIFICATIONS SZD 0.200 (5.08) 믺 0.195 (4.95) ġ - 0.39 (9.91) SURFACE MOUNT LAND PATTERN 0.175 (4.45) 0.025 0.018 0.30 (7.62) 0.010 (0.25) Weight: 0.035oz. (1g) maximum Case: 6-pin dual in-line, filled epoxy 0.020 (0.51) Tolerances (Unless otherwise specified) 0.XX = +/-0.010 (+/-0.25) 0.XXX = +/-0.005 (+/-0.13)0.100 (2.54)

Figure 1

TYPICAL WIRING DIAGRAM

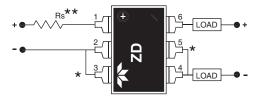
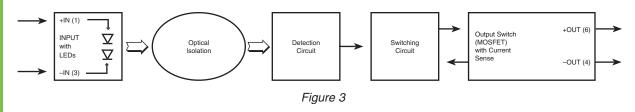


Figure 2

FUNCTIONAL BLOCK DIAGRAM



^{**}Series resistor required to limit input current to 20mA maximum

Short-Circuit Protected



Thermal Shock

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GENERAL SPECIFICATIONS

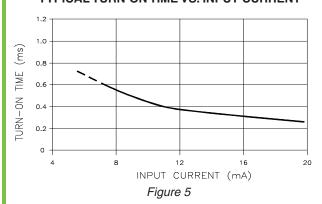
(+25°C ambient temperature unless otherwise specified)

ENVIRONMENTAL SPECIFICATIONS

	Min	Max	Units
Operating Temperature	-55	+105	°C
Storage Temperature	-55	+125	°C
Junction Temperature @1A		+125	°C
Thermal Resistance θ_{JA}		+125	°C/W
Shock	1500		g
Vibration	100		g
Dielectric Strength	1500		Vac
Insulation Resistance (@500 Vdc)	10 ⁹		Ohm
Input to Output Capacitance		5	pF
Resistance to Soldering Heat	MIL STD	202, me	thod 210
Solderability	MIL STD	202, me	thod 208

TYPICAL TURN-ON TIME VS. INPUT CURRENT

MIL STD 202, method 107



TYPICAL OVERLOAD TRIP CURRENT VS. TIME

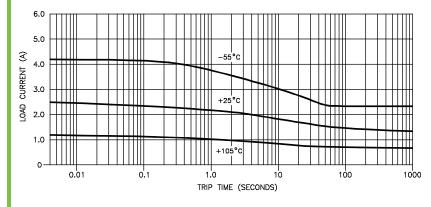


Figure 7

CONTROL CURRENT VS. INPUT VOLTAGE

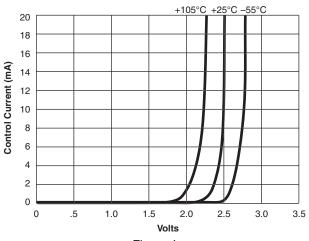


Figure 4

LOAD CURRENT VS. AMBIENT TEMPERATURE

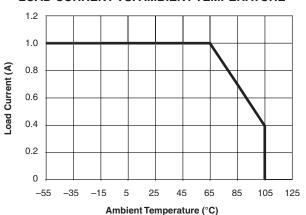


Figure 6

NOTES:

- 1. The ZD20CD relay's input current should be limited to between 8 and 20mA. An external resistor whose value = $(V_{\rm IN}-2.5~{\rm volts}) \div 0.012$ Amps is a good choice for limiting input current.
- 2. Relay input transitions should be less than 1.0 millisecond.
- 3. Loads may be attached to either the positive or negative output terminal.
- 4. Maximum load current ratings are with the relay in free air and soldered to a printed circuit board.
- 5. Timing is measured from the input current transition to the 10% or 90% points on the output voltage transition.
- 6. Overload conditions (including shorted loads) are specified for load supply voltages to 60 Vdc maximum.
- 7. For through-hole-PCB-solder-attaching ZD20CD series relays, the wave-solder or solder pot operations are limited to +260°C maximum for 10 seconds, maximum.
- 8. For surface-mount-solder-attaching SZD20CD series relays, in IR heating or convection heating systems, the component temperature is limited to +235°C maximum for 10 seconds maximum.